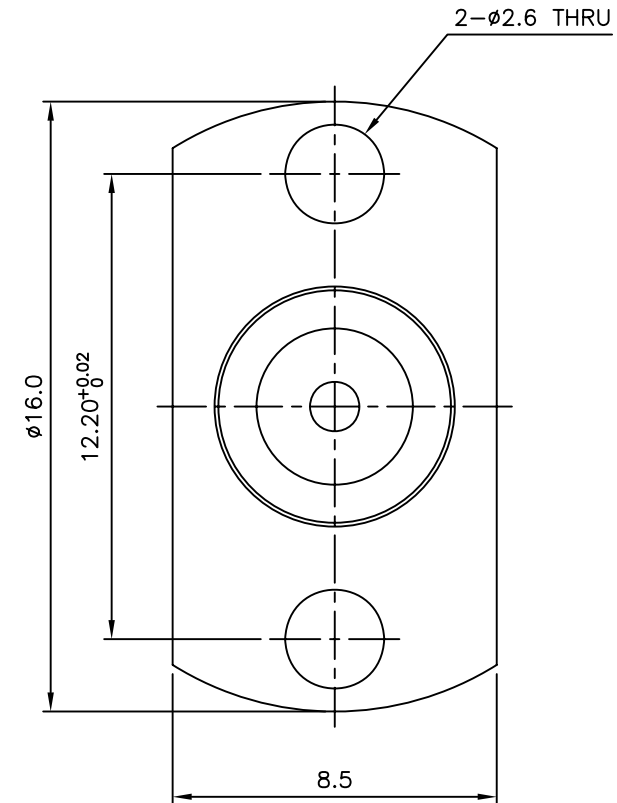
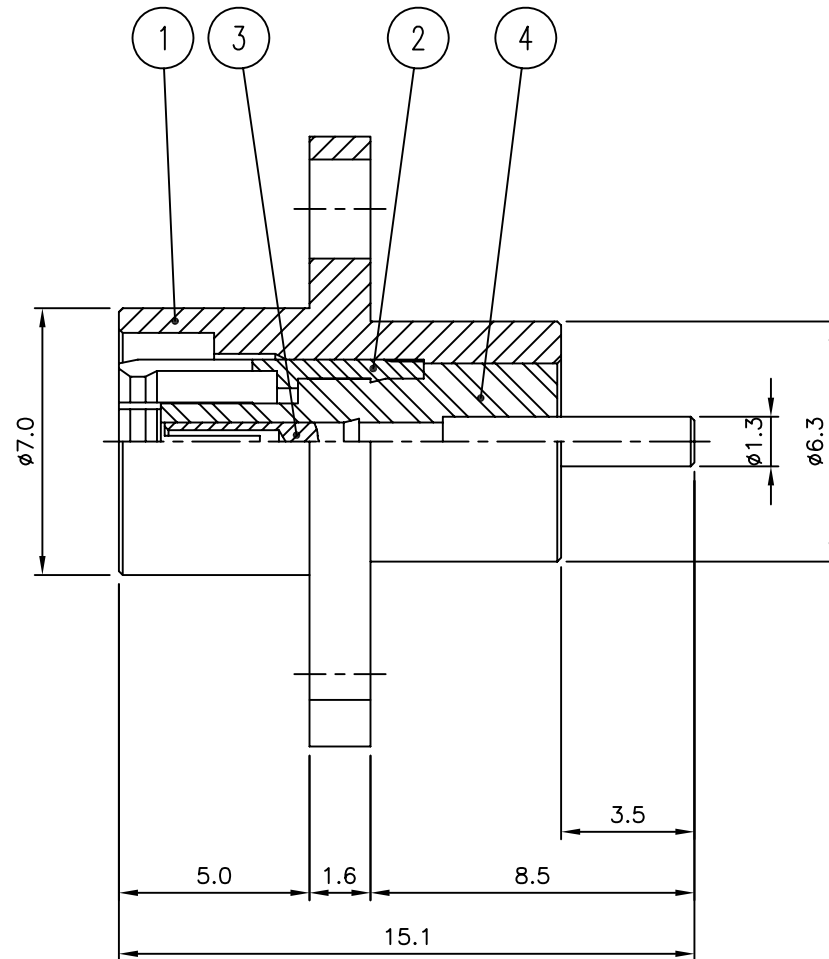


REVISION					
REV	DESCRIPTION	DRAWN	APPR	DATE	
IR	Initial Registration	M.H.SONG	I.C.KIM	2014.03.05.	
1	[설번처리 No.201504-0003] BODY, JACK 표준화 치수 적용	H.J.LEE	I.C.KIM	2015.04.22.	



4	INSULATOR	1	TEFLON		DIN02040-N/1
3	CONTACT	1	BeCu	Gold Plate	DCT02634-5/1
2	JACK	1	MBsBD	Gold Plate	DJA00159-5/4 DJA00159-5/3
1	BODY	1	MBsBD	Gold Plate	DBD03113-5/2
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2015. 04. 22.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL		CHECKED BY		KJ COMTECH CO.,LTD. TITLE SMBL50 SOLDER END JS-2H
		DRAWN BY	H.J.LEE	
FINISH		SCALE	5/1	A4 DWG NO. CN02830-7/2 REVISION 1 SHEET 1 of 1
		UNIT	mm	